Constructing an Associative Memory System Using Spiking Neural Network

A Seminar Report

submitted by

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PKD19CS046

to

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of

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in

Computer Science and Engineering

DEPARTMENT OF COMPUTER SCIENCE AND ENGINEERING

GOVERNMENT ENGINEERING COLLEGE PALAKKAD

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DECEMBER 2022

DEPT. OF COMPUTER SCIENCE ENGINEERING GOVRNMENT ENGINEERING COLLEGE PALAKKAD

2022 - 23

CERTIFICATE

This is to certify that the report entitled **Constructing an Associative Memory System Using Spiking Neural Network** submitted by **SANKAR VINAYAK E P** (PKD19CS046), to the APJ Abdul Kalam Technological University in partial fulfillment of the B.Tech. degree in Computer Science and Engineering is a bonafide record of the seminar work carried out by him under our guidance and supervision. This report in any form has not been submitted to any other University or Institute for any purpose.

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DECLARATION

I SANKAR VINAYAK E P hereby declare that the seminar report **Constructing an Associative Memory System Using Spiking Neural Network**, submitted for partial fulfillment of the requirements for the award of degree of Bachelor of Technology of the APJ Abdul Kalam Technological University, Kerala is a bonafide work done by me under supervision of Liji L Dominic

This submission represents my ideas in my own words and where ideas or words of others have been included, I have adequately and accurately cited and referenced the original sources.

I also declare that I have adhered to ethics of academic honesty and integrity and have not misrepresented or fabricated any data or idea or fact or source in my submission. I understand that any violation of the above will be a cause for disciplinary action by the institute and/or the University and can also evoke penal action from the sources which have thus not been properly cited or from whom proper permission has not been obtained. This report has not been previously formed the basis for the award of any degree, diploma or similar title of any other University.

Sreekrishnapuram

15-12-2022

SANKAR VINAYAK E P

Abstract

This document contains essential templates required to write technical reports using LaTeX. This template may be used for the preparation of B.Tech seminar reports of APJ Abdul Kalam Technological University, Kerala. Also minimum working examples to create equations, include figure, include table, table of contents symbols list and bibliographic citation in a LaTeX document are provided.

Please note that this template is provided without warranty on an AS IS basis.

JIM

Acknowledgement

I take this opportunity to express my deepest sense of gratitude and sincere thanks to everyone who helped me to complete this work successfully. I express my sincere thanks to **Dr. Sabitha**, Head of Department, Computer Science and Engineering, College of Engineering Sreekrishnapuram for providing me with all the necessary facilities and support.

I would like to express my sincere gratitude to **Swaraj** and **Prof. Seminar coordinator 2**, department of Computer Science and Engineering, College of Engineering Sreekrishnapuram for their support and co-operation.

I would like to place on record my sincere gratitude to my seminar guide **Liji L Dominic**, Assistant Professor, Computer Science and Engineering, College of Engineering for the guidance and mentorship throughout the course.

Finally I thank my family, and friends who contributed to the succesful fulfilment of this seminar work.

SANKAR VINAYAK E P

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Ω	Unit of Resistance
$\varepsilon^{'}$	Real part of dielectric constant
c	Speed of light
λ	Wavelength
δ	Delta

Chapter 1

Introduction

Lorem ipsum dolor sit amet, consectetuer adipiscing elit. Ut purus elit, vestibulum ut, placerat ac, adipiscing vitae, felis. Curabitur dictum gravida mauris. Nam arcu libero, nonummy eget, consectetuer id, vulputate a, magna. Donec vehicula augue eu neque. Pellentesque habitant morbi tristique senectus et netus et malesuada fames ac turpis egestas. Mauris ut leo. Cras viverra metus rhoncus sem. Nulla et lectus vestibulum urna fringilla ultrices. Phasellus eu tellus sit amet tortor gravida placerat. Integer sapien est, iaculis in, pretium quis, viverra ac, nunc. Praesent eget sem vel leo ultrices bibendum. Aenean faucibus. Morbi dolor nulla, malesuada eu, pulvinar at, mollis ac, nulla. Curabitur auctor semper nulla. Donec varius orci eget risus. Duis nibh mi, congue eu, accumsan eleifend, sagittis quis, diam. Duis eget orci sit amet orci dignissim rutrum.

Chapter 2

Literature Review

Technical writing is writing or drafting technical communication used in technical and occupational fields [1], such as computer hardware and software [2], engineering, chemistry, aeronautics, robotics, finance [3], medical, consumer electronics, biotechnology, and forestry. Technical writing encompasses the largest sub-field in technical communication. See figure 2.1 that shows the autonomous systems in Internet.

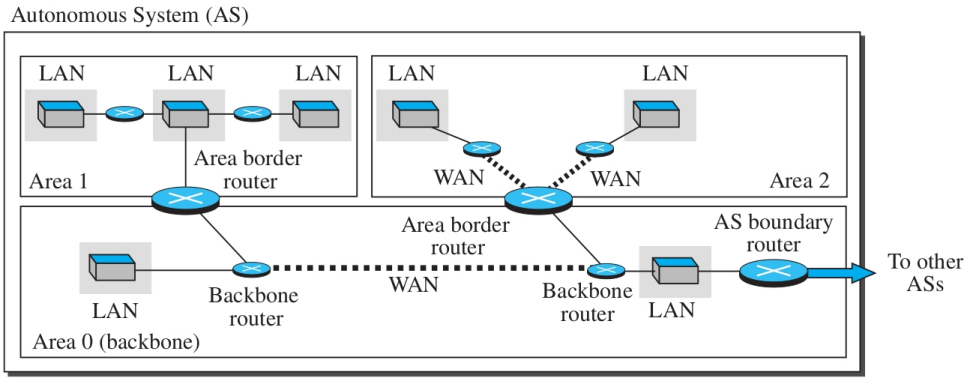

Figure 2.1: Autonomous System Hierarchy

2.1 section1

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nascetur ridiculus mus. Aliquam tincidunt urna. Nulla ullamcorper vestibulum turpis. Pellentesque cursus luctus mauris.

2.1.1 title 2

Nulla malesuada porttitor diam. Donec felis erat, congue non, volutpat at, tincidunt tristique, libero. Vivamus viverra fermentum felis. Donec nonummy pellentesque ante. Phasellus adipiscing semper elit. Proin fermentum massa ac quam. Sed diam turpis, molestie vitae, placerat a, molestie nec, leo. Maecenas lacinia. Nam ipsum ligula, eleifend at, accumsan nec, suscipit a, ipsum. Morbi blandit ligula feugiat magna. Nunc eleifend consequat lorem. Sed lacinia nulla vitae enim. Pellentesque tincidunt purus vel magna. Integer non enim. Praesent euismod nunc eu purus. Donec bibendum quam in tellus. Nullam cursus pulvinar lectus. Donec et mi. Nam vulputate metus eu enim. Vestibulum pellentesque felis eu massa.
The system is described by the equation 2.1 below. Here y is the ordinate and x is the abscissa , m is the slope and c a constant.

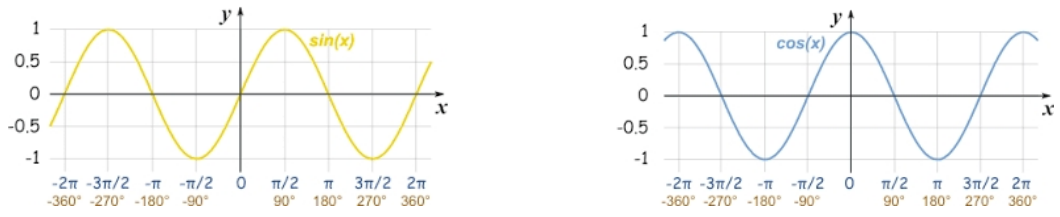
$$y = mx + c \tag{2.1}$$

Page centered and unnumbered multiple equations. The * symbol supresses equation numbering.

$$2x - 5y = 8$$

$$3x + 9y = -12$$

Side by side figures can be created using this environment. See fig 2.2 below.



(a) Sine Wave (b) Cosine Wave

Figure 2.2: The Sine and Cosine waves

Chapter 3

Results

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quis congue purus metus ultricies tellus. Proin et quam. Class aptent taciti sociosqu ad litora torquent per conubia nostra, per inceptos hymenaeos. Praesent sapien turpis, fermentum vel, eleifend faucibus, vehicula eu, lacus.

Table 3.1: test table

Sl. No	Item 1	Itm 2
1	37	45
2	42	23
3	47	1
4	52	-21
5	57	-43
6	62	-65
7	67	-87
8	72	-109
9	77	-131
10	82	-153

Chapter 4

Conclusion

Nam dui ligula, fringilla a, euismod sodales, sollicitudin vel, wisi. Morbi auctor lorem non justo. Nam lacus libero, pretium at, lobortis vitae, ultricies et, tellus. Donec aliquet, tortor sed accumsan bibendum, erat ligula aliquet magna, vitae ornare odio metus a mi. Morbi ac orci et nisl hendrerit mollis. Suspendisse ut massa. Cras nec ante. Pellentesque a nulla. Cum sociis natoque penatibus et magnis dis parturient montes, nascetur ridiculus mus. Aliquam tincidunt urna. Nulla ullamcorper vestibulum turpis. Pellentesque cursus luctus mauris.

References

[1] HU, Yun Chao, et al., *Mobile edge computing?A key technology towards 5G*, ETSI white paper, 2015, vol. 11, no 11, p. 1-16.

[2] @online Raspberry pi, `https://www.raspberrypi.org/` Online; accessed 10-June-2019

[3] HU, Yun Chao, et al., *Mobile edge computing?A key technology towards 5G*, ETSI white paper, 2015, vol. 11, no 11, p. 1-16.